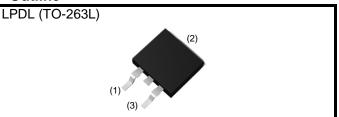


RGS60NL65DHRBTL

650V 30A Field Stop Trench IGBT

V _{CES}	650V
Ι _C	30A
V _{CE(sat) (Typ.)}	1.65V
P _D	228W

Outline



Features

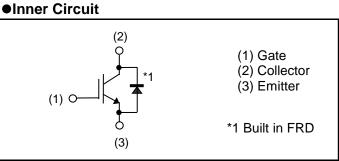
- 1) Qualified to AEC-Q101
- 2) Low Collector Emitter Saturation Voltage
- 3) Short Circuit Withstand Time 8µs
- 4) Built in Very Fast & Soft Recovery FRD
- 5) Pb free Lead Plating ; RoHS Compliant

Application

General Inverter

for Automotive and Industrial Use

Heater for Automotive



Packaging Specifications

	Packaging	Taping
	Reel Size (mm)	330
Type	Tape Width (mm)	24
Туре	Basic Ordering Unit (pcs)	1,000
	Packing Code	TL
	Marking	RGS60NL65D

•Absolute Maximum Ratings (at T_c = 25°C unless otherwise specified)

Parameter		Value	Unit
Collector - Emitter Voltage		650	V
Gate - Emitter Voltage		±30	V
$T_{\rm C} = 25^{\circ}{\rm C}$	Ι _C	59	Α
$T_c = 100^{\circ}C$	Ι _C	40	Α
Pulsed Collector Current		90	Α
$T_{\rm C} = 25^{\circ}{\rm C}$	$T_{\rm C} = 25^{\circ}{\rm C}$ $I_{\rm F}$		Α
$T_{\rm C} = 100^{\circ}{\rm C}$	١ _F	25	Α
Diode Pulsed Forward Current		90	Α
$T_{\rm C} = 25^{\circ}{\rm C}$	P _D	228	W
$T_{\rm C} = 100^{\circ}{\rm C}$	P _D	119	W
Operating Junction Temperature		-40 to +175	°C
Storage Temperature		-55 to +175	°C
	$T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$ $T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$ $T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$		$\begin{array}{c c c c c c c c c c c c c c c c c c c $

*1 Pulse width limited by T_{jmax.}

Thermal Resistance

Parameter	Symbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.63	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	1.55	°C/W

•IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions		Unit			
Falameter	Symbol	Conditions	Min.	Тур.	Max.	Onic	
Collector - Emitter Breakdown Voltage	BV _{CES}	I _C = 10μΑ, V _{GE} = 0V	650	-	-	V	
		$V_{CE} = 650V, V_{GE} = 0V,$					
Collector Cut - off Current	I _{CES}	T _j = 25°C	-	-	10	μA	
		Tj = 175°C	-	0.1	-	mA	
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	-	±200	nA	
Gate - Emitter Threshold Voltage	$V_{\text{GE(th)}}$	V _{CE} = 5V, I _C = 1.5mA	5.0	6.0	7.0	V	
		$I_{C} = 30A, V_{GE} = 15V,$					
Collector - Emitter Saturation Voltage	V _{CE(sat)}	T _j = 25°C	-	1.65	2.10	V	
		T _j = 175°C	-	2.15	-	V	



•IGBT Electrical Characteristics	(at T	$= 25^{\circ}C$	unless	otherwise	specified)
	ιαιι		0111000		Specifica,

Deremeter	Symbol	Conditions		11-20		
Parameter	Farameter Symbol Conditions		Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	V _{CE} = 30V,	-	980	-	
Output Capacitance	C _{oes}	V _{GE} = 0V,	-	80	-	pF
Reverse transfer Capacitance	C _{res}	f = 1MHz	-	13	-	
Total Gate Charge	Qg	V _{CE} = 400V,	-	36	-	
Gate - Emitter Charge	Q_{ge}	I _C = 30A,	-	10	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	15	-	
Turn - on Delay Time	t _{d(on)}		-	31	-	
Rise Time	t _r	$I_{\rm C} = 30$ A, $V_{\rm CC} = 400$ V,	-	13	-	
Turn - off Delay Time	t _{d(off)}	V _{GE} = 15V, R _G = 10Ω, T _i = 25°C	-	94	-	ns -
Fall Time	t _f	Inductive Load	-	91	-	
Turn - on Switching Loss	Eon	*E _{on} include diode reverse recovery	-	0.65	-	
Turn - off Switching Loss	E _{off}	, , , , , , , , , , , , , , , , , , ,	-	0.79	-	mJ
Turn - on Delay Time	t _{d(on)}		-	31	-	
Rise Time	t _r	$I_{\rm C} = 30$ A, $V_{\rm CC} = 400$ V,	-	15	-	1
Turn - off Delay Time	t _{d(off)}	V _{GE} = 15V, R _G = 10Ω, T _i = 175°C	-	111	-	ns
Fall Time	t _f	Inductive Load	-	138	-	1
Turn - on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	0.73	-	
Turn - off Switching Loss	E _{off}	, ,	-	1.03	-	mJ
Reverse Bias Safe Operating Area	RBSOA	$I_{C} = 90A, V_{CC} = 520V,$ $V_{P} = 650V, V_{GE} = 15V,$ $R_{G} = 50\Omega, T_{j} = 175^{\circ}C$	FULL SQUARE		-	
Short Circuit Withstand Time	t _{sc}	V _{CC} ≤ 360V, V _{GE} = 15V, T _j = 25°C	8	-	-	μs
Short Circuit Withstand Time	t _{sc} *2	V _{CC} ≤ 360V, V _{GE} = 15V, T _j = 150°C	6	-	-	μs

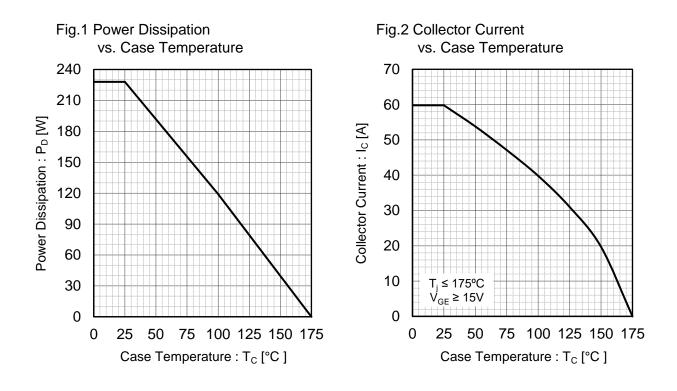
*2 Design assurance without measurement



•FRD Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Doromotor	C: una ha a h	Conditions	Values				
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
		I _F = 25A,					
Diode Forward Voltage	V_{F}	T _j = 25°C	-	1.5	1.95	V	
		T _j = 175°C	-	1.6	-		
Diode Reverse Recovery Time	t _{rr}		-	95	-	ns	
Diode Peak Reverse Recovery Current	I _{rr}	$I_F = 25A,$ $V_{CC} = 400V,$ $di_F/dt = 200A/\mu s,$ $T_j = 25^{\circ}C$	-	6.9	-	А	
Diode Reverse Recovery Charge	Q _{rr}		-	0.37	-	μC	
Diode Reverse Recovery Energy	E _{rr}		-	16	-	μJ	
Diode Reverse Recovery Time	t _{rr}		-	127	-	ns	
Diode Peak Reverse Recovery Current	I _{rr}	I _F = 25A, V _{CC} = 400V,	-	8.3	-	А	
Diode Reverse Recovery Charge	Q _{rr}	di _F /dt = 200A/µs, T _j = 175°C	-	0.64	-	μC	
Diode Reverse Recovery Energy	Err		-	34	-	μJ	





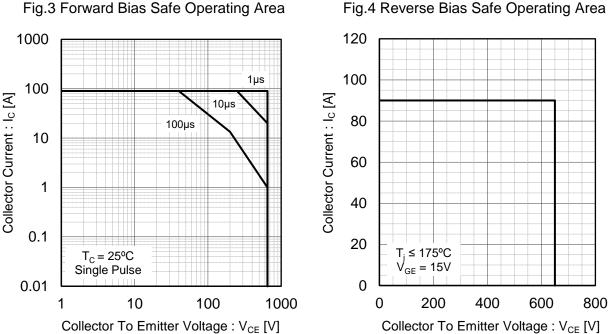


Fig.4 Reverse Bias Safe Operating Area

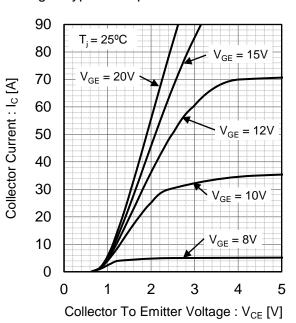
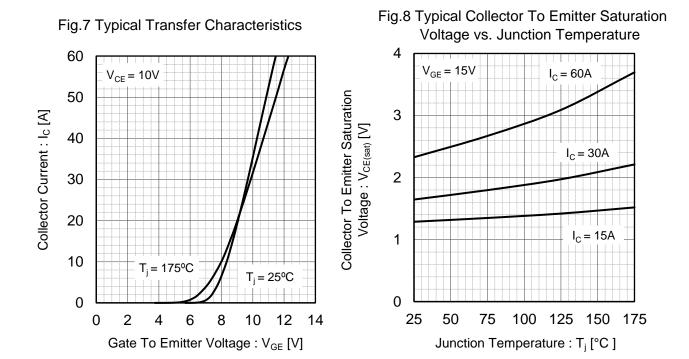


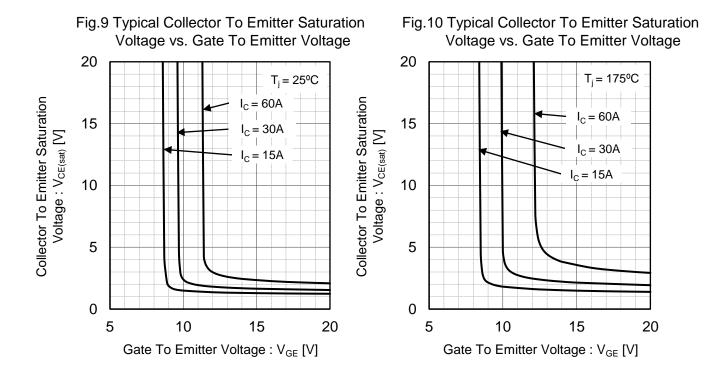
Fig.5 Typical Output Characteristics

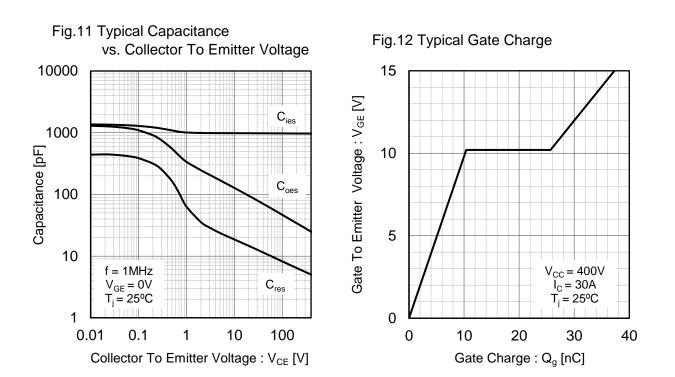
90 T_j = 175°C 80 70 Collector Current : I_c [A] $V_{GE} = 20V$ 60 $V_{GE} = 15V$ 50 $V_{GE} = 12V$ 40 30 $V_{GE} = 10V$ 20 10 $V_{GE} = 8V$ 0 2 0 1 3 4 5 Collector To Emitter Voltage : V_{CE} [V]

Fig.6 Typical Output Characteristics



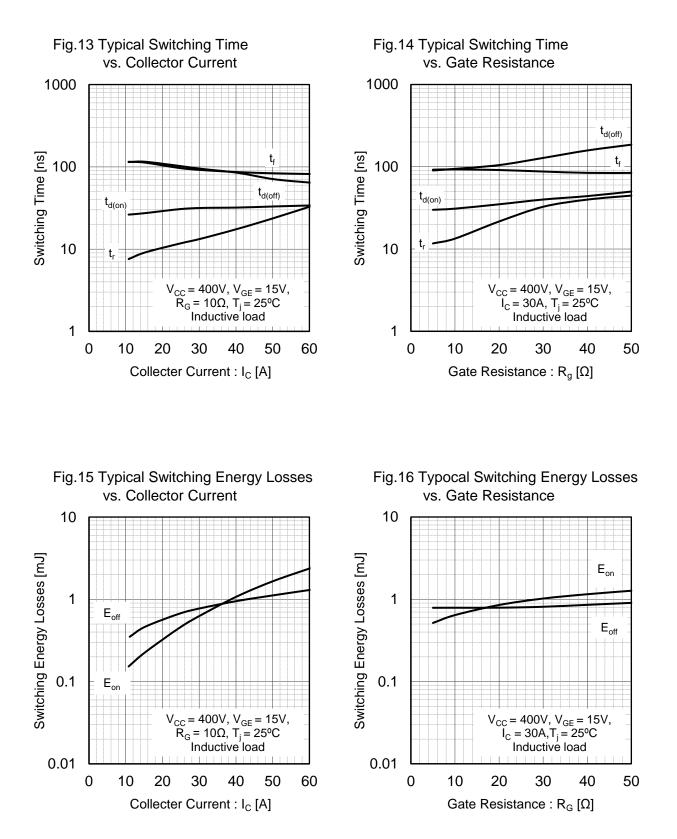




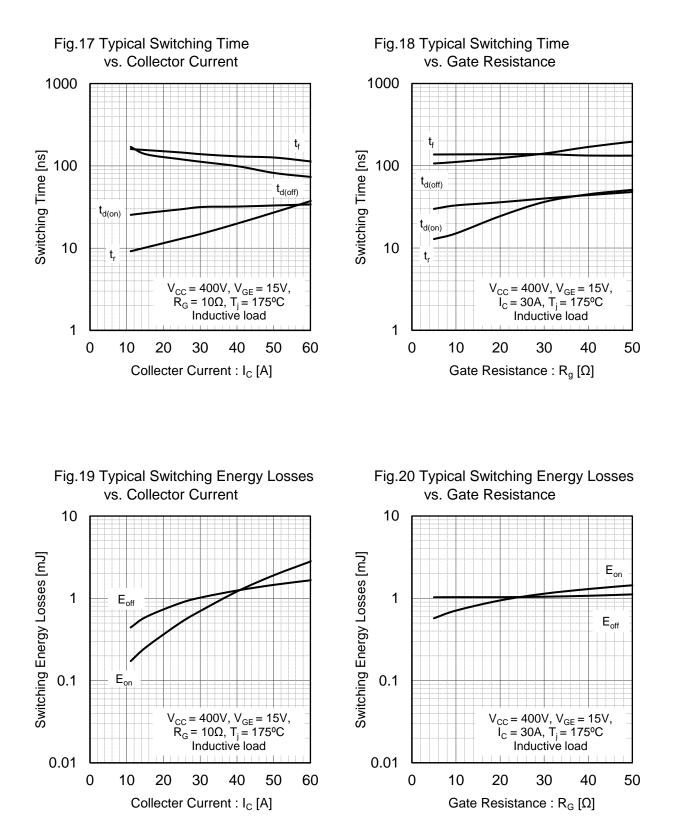


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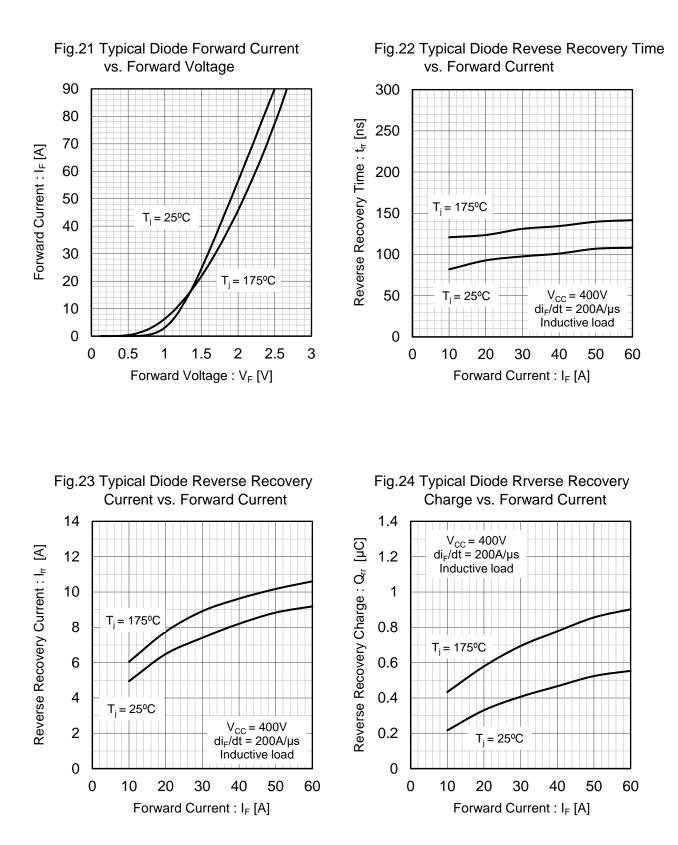












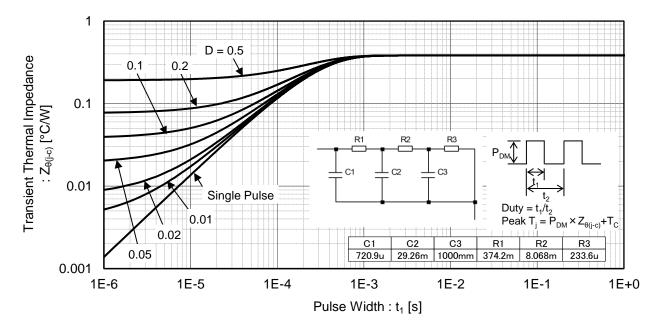
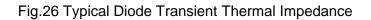
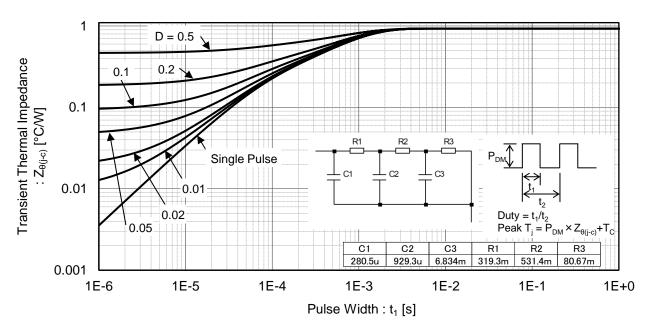


Fig.25 Typical IGBT Transient Thermal Impedance







Inductive Load Switching Circuit and Waveform

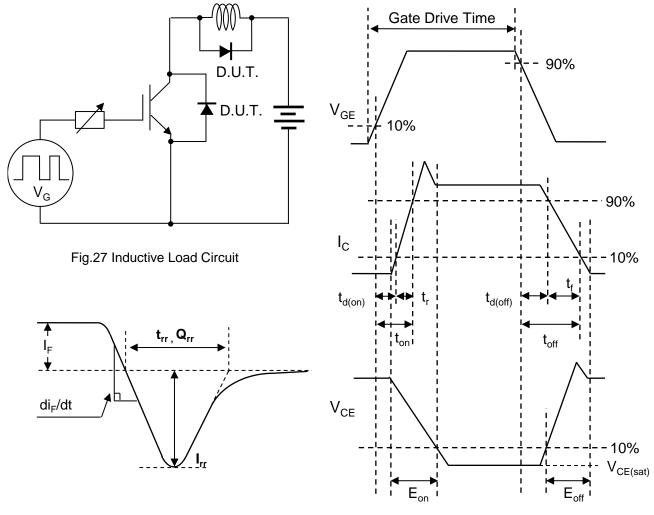


Fig.29 Diode Reverse Recovery Waveform

Fig.28 Inductive Load Waveform



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